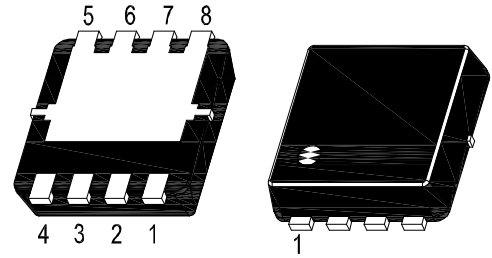
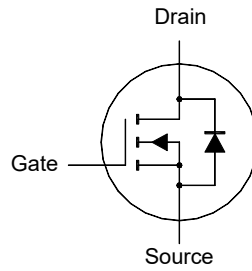


WTM303N095LS-AH

N-Channel Enhancement Mode MOSFET

Features

- AEC-Q101 Qualified
- Low $R_{DS(ON)}$
- Low Input Capacitance
- Low Input/Output Leakage
- Halogen and Antimony Free(HAF), RoHS compliant



1. Source 2. Source 3. Source 4. Gate
5. Drain 6. Drain 7. Drain 8. Drain
DFN3030 Plastic Package

Application

- Motor/Body Load Control
- Load Switch
- DC-DC converters and Off-line UPS

Key Parameters

Parameter	Value	Unit
BV_{DSS}	30	V
$R_{DS(ON)}$ Max	7 @ $V_{GS} = 10$ V	m Ω
	11 @ $V_{GS} = 4.5$ V	m Ω
$V_{GS(th)}$ typ	1.6	V
Q_g typ	24 @ $V_{GS} = 10$ V	nC

Absolute Maximum Ratings (at $T_a = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	$T_c = 25^\circ\text{C}$	42
		$T_c = 100^\circ\text{C}$	27
Peak Drain Current, Pulsed ¹⁾	I_{DM}	120	A
Single Pulse Avalanche Current	I_{AS}	19	A
Single Pulse Avalanche Energy ²⁾	E_{AS}	18	mJ
Power Dissipation	P_D	$T_c = 25^\circ\text{C}$	25
		$T_c = 100^\circ\text{C}$	10
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to + 150	$^\circ\text{C}$

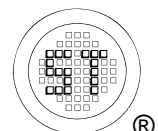
Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Case	$R_{\theta JC}$	5	$^\circ\text{C/W}$
Thermal Resistance from Junction to Ambient ³⁾	$R_{\theta JA}$	50	$^\circ\text{C/W}$

¹⁾ Pulse Test: Pulse Width ≤ 100 μs , Duty Cycle $\leq 2\%$, Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)} = 150^\circ\text{C}$.

²⁾ Limited by $T_{J(MAX)}$, starting $T_J = 25^\circ\text{C}$, $L = 0.1$ mH, $R_g = 25$ Ω , $I_D = 19$ A, $V_{GS} = 10$ V.

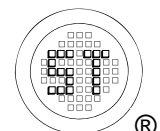
³⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.



WTM303N095LS-AH

Characteristics at $T_a = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at $I_D = 250 \mu\text{A}$	BV_{DSS}	30	-	-	V
Drain-Source Leakage Current at $V_{DS} = 30 \text{ V}$	I_{DSS}	-	-	1	μA
Gate Leakage Current at $V_{GS} = \pm 20 \text{ V}$	I_{GSS}	-	-	± 100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$	$V_{GS(th)}$	1	-	2.5	V
Drain-Source On-State Resistance at $V_{GS} = 10 \text{ V}$, $I_D = 15 \text{ A}$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 10 \text{ A}$	$R_{DS(on)}$	-	6 9	7 11	m Ω
DYNAMIC PARAMETERS					
Forward Transconductance at $V_{DS} = 5 \text{ V}$, $I_D = 15 \text{ A}$	g_{fs}	-	15	-	S
Gate resistance at $V_{DS} = 0 \text{ V}$, $f = 1 \text{ MHz}$	R_g	-	1.6	-	Ω
Input Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 15 \text{ V}$, $f = 1 \text{ MHz}$	C_{iss}	-	1122	-	pF
Output Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 15 \text{ V}$, $f = 1 \text{ MHz}$	C_{oss}	-	140	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0 \text{ V}$, $V_{DS} = 15 \text{ V}$, $f = 1 \text{ MHz}$	C_{rss}	-	105	-	pF
Gate charge total at $V_{DS} = 15 \text{ V}$, $I_D = 15 \text{ A}$, $V_{GS} = 4.5 \text{ V}$ at $V_{DS} = 15 \text{ V}$, $I_D = 15 \text{ A}$, $V_{GS} = 10 \text{ V}$	Q_g	-	12 24	-	nC
Gate to Source Charge at $V_{DS} = 15 \text{ V}$, $I_D = 15 \text{ A}$, $V_{GS} = 4.5 \text{ V}$	Q_{gs}	-	3.3	-	nC
Gate to Drain Charge at $V_{DS} = 15 \text{ V}$, $I_D = 15 \text{ A}$, $V_{GS} = 4.5 \text{ V}$	Q_{gd}	-	6	-	nC
Turn-On Delay Time at $V_{GS} = 10 \text{ V}$, $V_{DS} = 15 \text{ V}$, $I_D = 15 \text{ A}$, $R_g = 2.2 \Omega$	$t_{d(on)}$	-	13	-	nS
Turn-On Rise Time at $V_{GS} = 10 \text{ V}$, $V_{DS} = 15 \text{ V}$, $I_D = 15 \text{ A}$, $R_g = 2.2 \Omega$	t_r	-	71	-	nS
Turn-Off Delay Time at $V_{GS} = 10 \text{ V}$, $V_{DS} = 15 \text{ V}$, $I_D = 15 \text{ A}$, $R_g = 2.2 \Omega$	$t_{d(off)}$	-	13	-	nS
Turn-Off Fall Time at $V_{GS} = 10 \text{ V}$, $V_{DS} = 15 \text{ V}$, $I_D = 15 \text{ A}$, $R_g = 2.2 \Omega$	t_f	-	21	-	nS
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at $I_S = 1 \text{ A}$, $V_{GS} = 0 \text{ V}$	V_{SD}	-	0.7	1.2	V
Body-Diode Continuous Current	I_S	-	-	42	A
Body-Diode Continuous Current, Pulsed	I_{SM}	-	-	120	A
Body Diode Reverse Recovery Time at $I_S = 15 \text{ A}$, $di/dt = 100 \text{ A} / \mu\text{s}$	t_{rr}	-	6.5	-	nS
Body Diode Reverse Recovery Charge at $I_S = 15 \text{ A}$, $di/dt = 100 \text{ A} / \mu\text{s}$	Q_{rr}	-	1.4	-	nC



Electrical Characteristics Curves

Fig. 1 Typical Output Characteristic

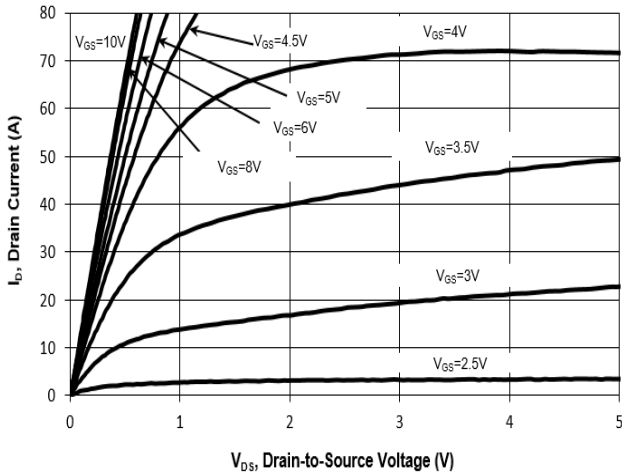


Fig. 2 Typical Transfer Characteristic

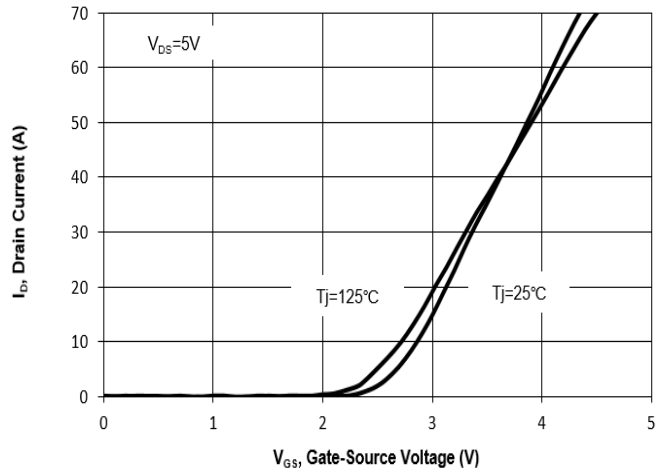


Fig. 3 on-Resistance vs. Gate Voltage

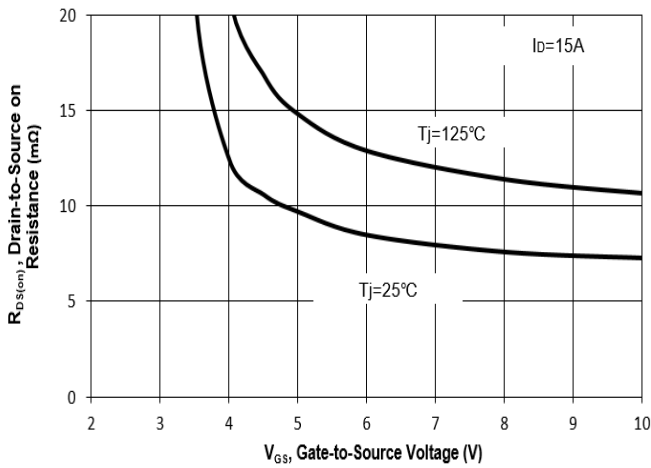


Fig. 4 on-Resistance vs. T_J

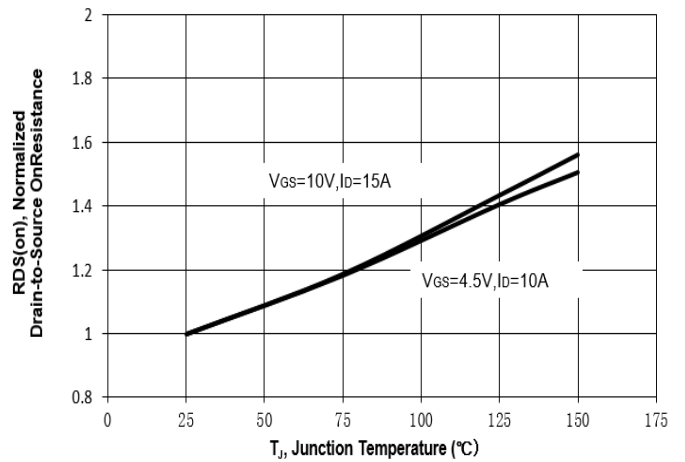


Fig. 5 on-Resistance vs. Drain Current

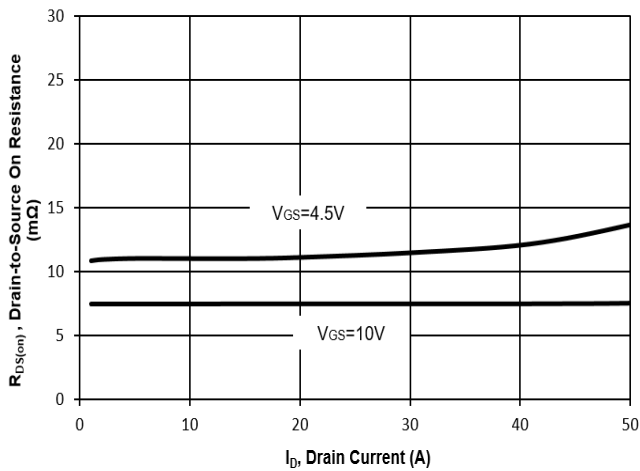
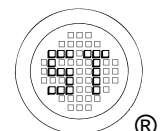
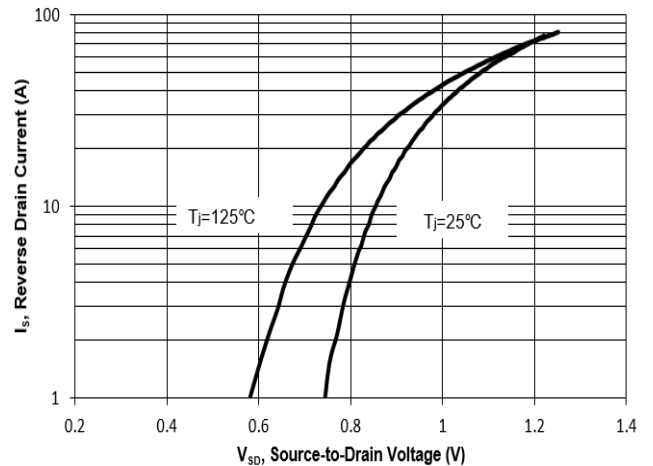


Fig. 6 Typical Body-Diode Forward Characteristic



Electrical Characteristics Curves

Fig. 7 $V_{(BR)DSS}$ vs. Junction Temperature

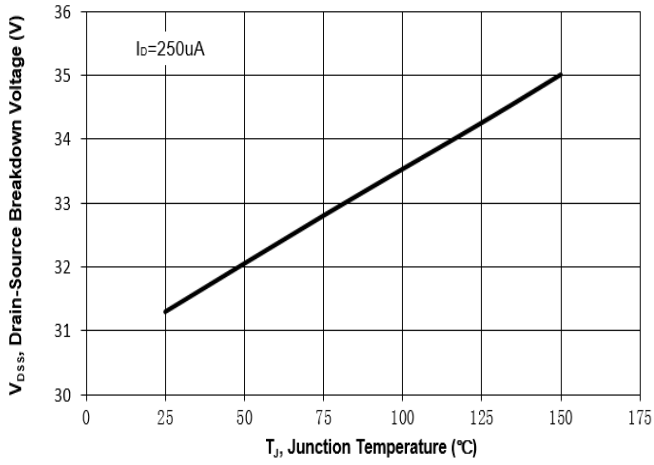


Fig. 8 Gate Threshold Variation vs. T_J

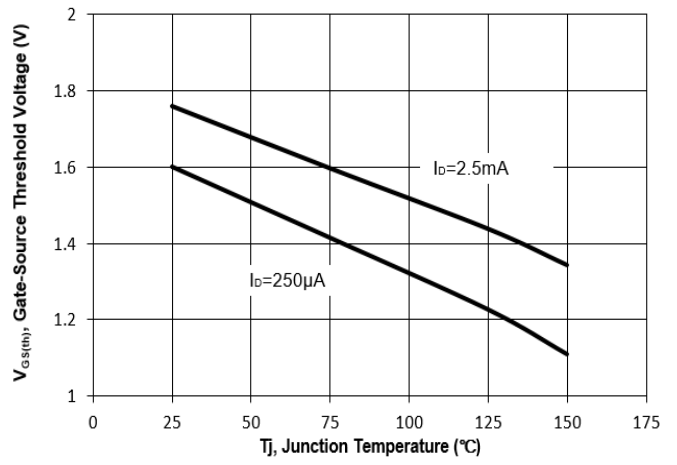


Fig. 9 Typical Junction Capacitance

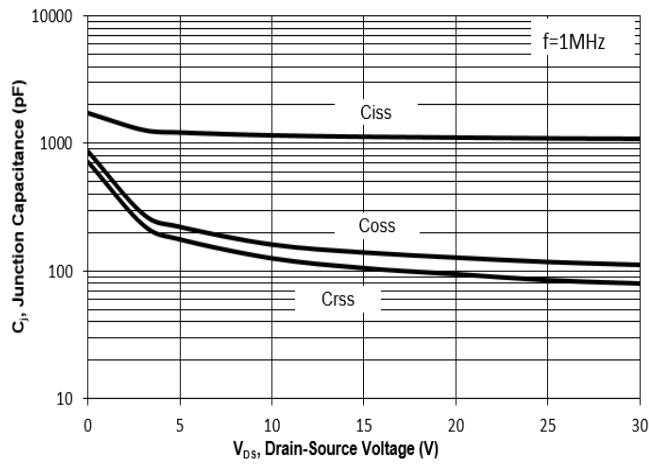


Fig. 10 Gate Charge

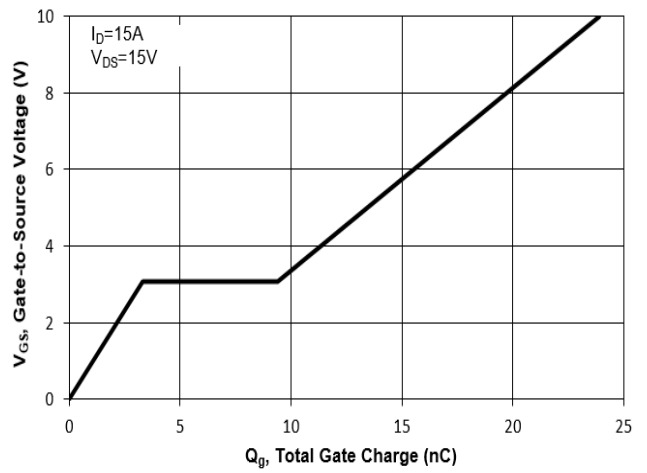


Fig. 11 Drain-Source Leakage Current vs. T_J

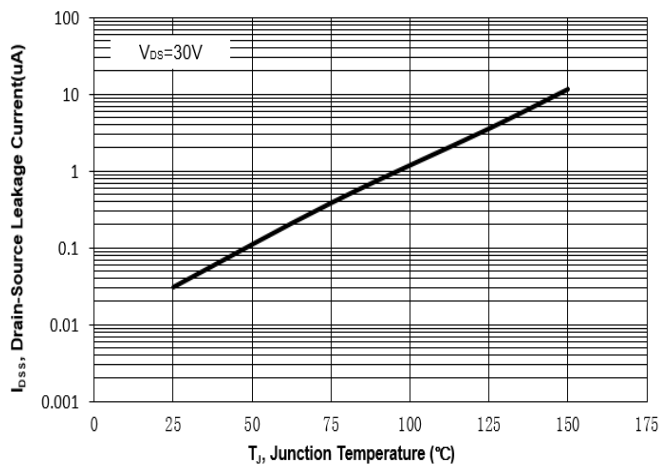
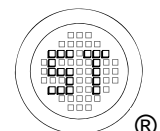
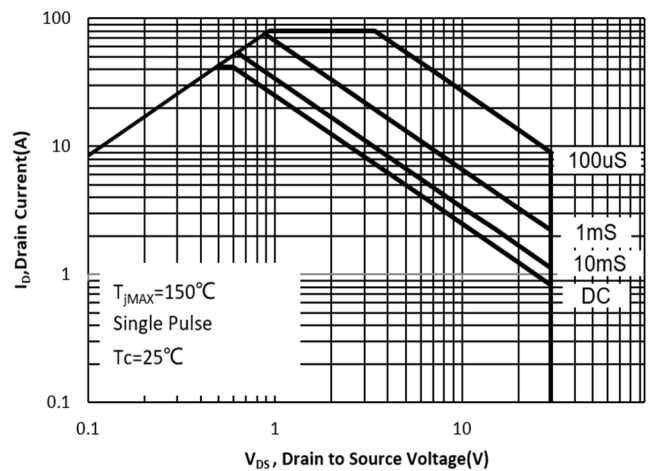


Fig. 12 Safe Operation Area



Electrical Characteristics Curves

Fig.13 Normalized Maximum Transient Thermal Impedance($Z_{\theta JA}$)

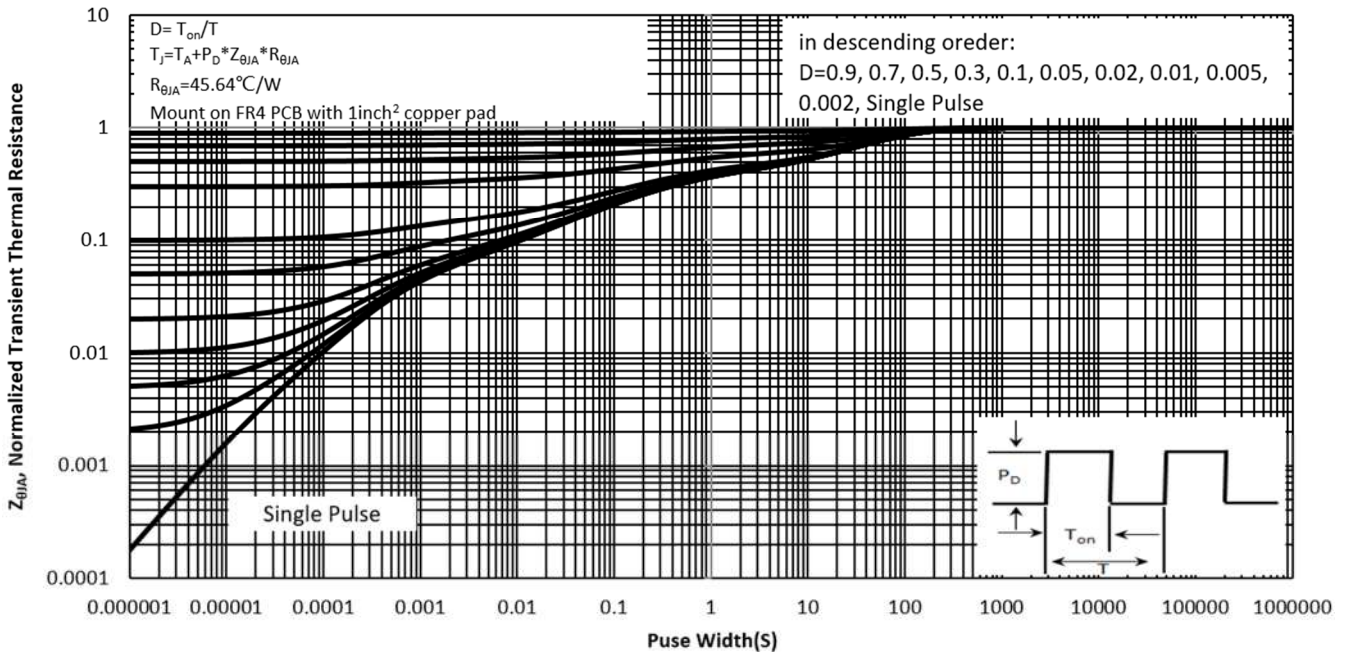
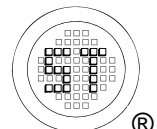
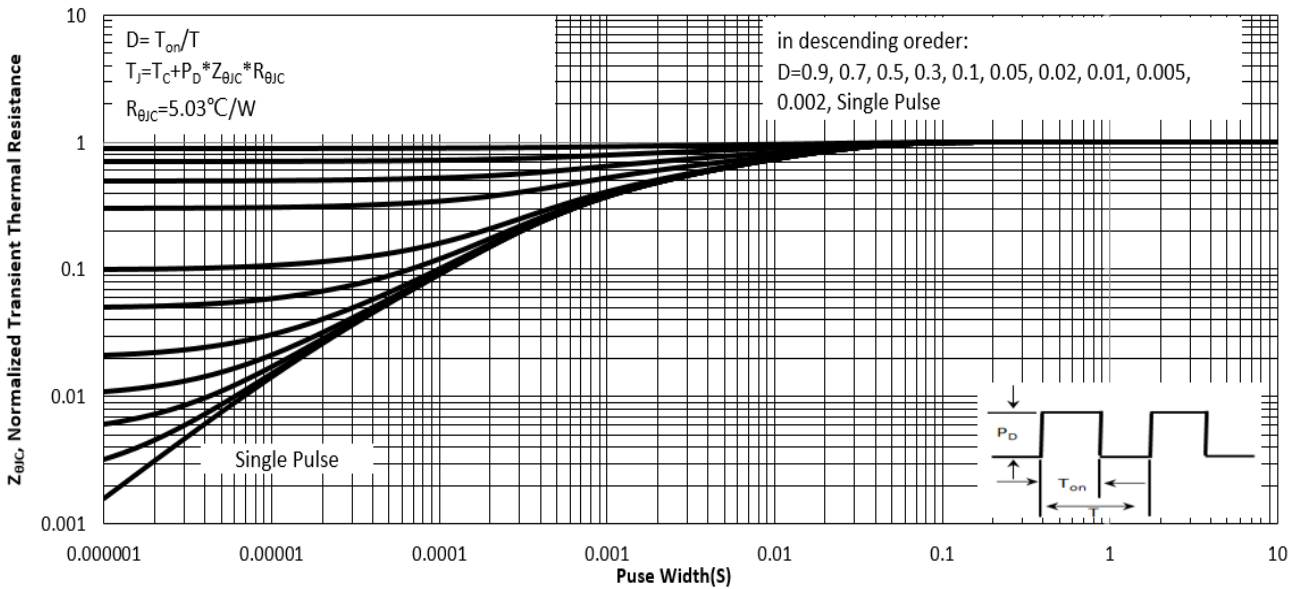


Fig.14 Normalized Maximum Transient Thermal Impedance($Z_{\theta JC}$)



Test Circuits

Fig.1-1 Switching times test circuit

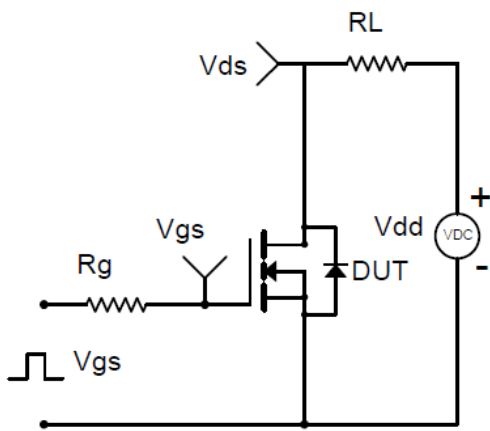


Fig.1-2 Switching Waveform

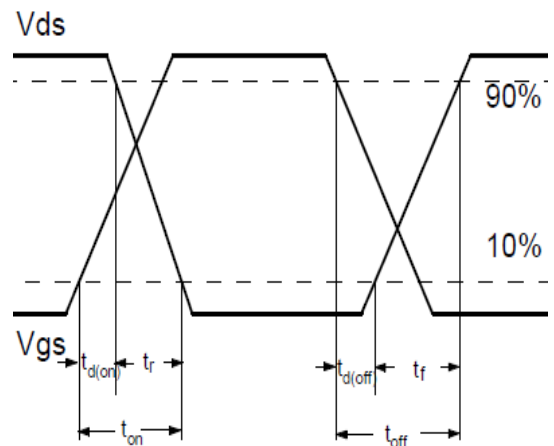


Fig.2-1 Gate charge test circuit

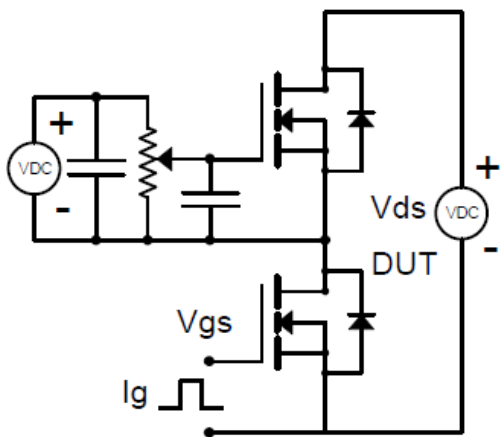


Fig.2-2 Gate charge waveform

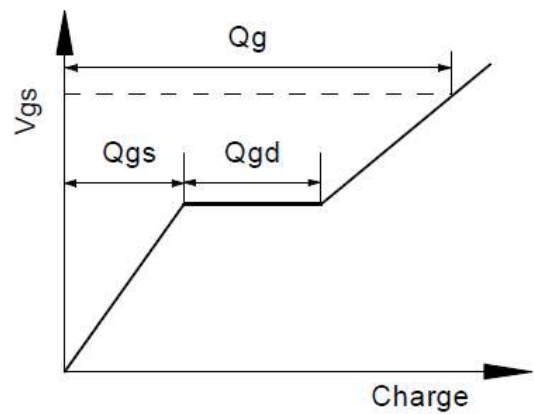


Fig.3-1 Avalanche test circuit

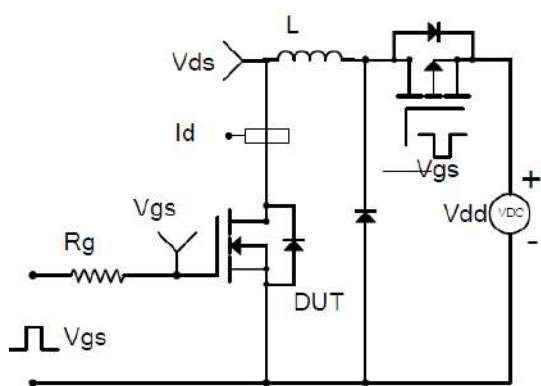
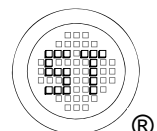
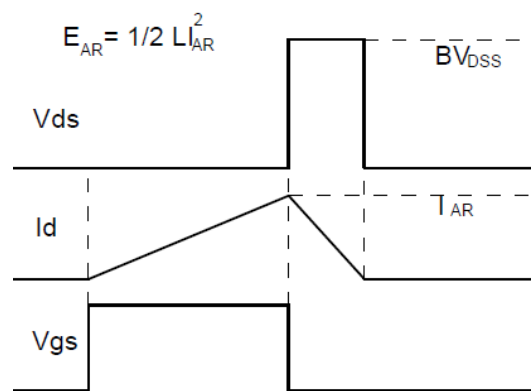


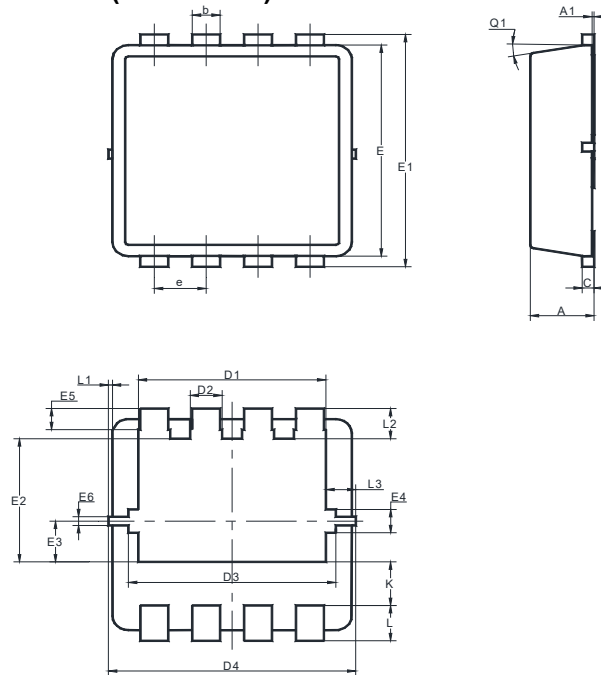
Fig.3-2 Avalanche waveform



WTM303N095LS-AH

Package Outline Dimensions (Units: mm)

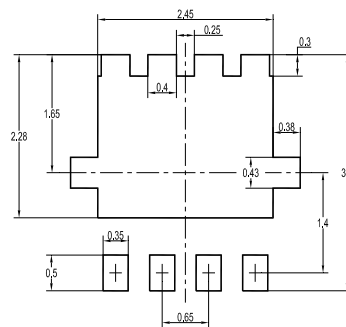
DFN3030



UNIT	A	A1	b	c	D1	D2	D3	D4	E	E1	E2	E3	E4
mm	0.9	0.05	0.35	0.25	2.6	0.5	2.7	3.2	3.1	3.3	1.85	0.68	0.43
	0.7	0	0.24	0.1	2.4	0.3	2.5	3	2.9	3.1	1.65	0.48	0.23

UNIT	E5	E6	e	K	L	L1	L2	L3	θ1
mm	0.4	0.25	0.7	0.72	0.5	0.1	0.53	0.475	12°
	0.2	0.15	0.6	0.52	0.3	0	0.33	0.275	0°

Recommended Soldering Footprint



Packing information

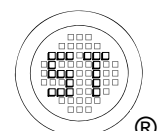
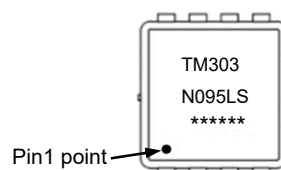
Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
DFN3030	12	8 ± 0.1	0.315 ± 0.004	330	13	5,000

Marking information

" TM303N095LS " = Part No.

" ***** " = Date Code Marking

Font type: Arial



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